## SN54ABT16245, SN74ABT16245A 16-BIT BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

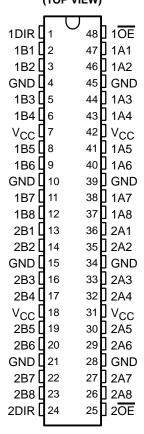
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- Members of the Texas Instruments Widebus™ Family
- State-of-the-Art EPIC-IIB™ BiCMOS Design Significantly Reduces Power Dissipation
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Typical V<sub>OLP</sub> (Output Ground Bounce) < 1 V at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C
- High-Impedance State During Power Up and Power Down
- Distributed V<sub>CC</sub> and GND Pin Configuration Minimizes High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Layout
- High-Drive Outputs (-32-mA I<sub>OH</sub>, 64-mA I<sub>OL</sub>)
- Package Options Include Plastic Thin Very Small-Outline (DGV), 300-mil Shrink Small-Outline (DL), and Thin Shrink Small-Outline (DGG) Packages and 380-mil Fine-Pitch Ceramic (WD) Flat Package Using 25-mil Center-to-Center Spacings

#### description

The SN54ABT16245 and SN74ABT16245A are 16-bit noninverting 3-state transceivers designed for synchronous two-way communication between data buses. The control-function implementation minimizes external timing requirements.

SN54ABT16245 . . . WD PACKAGE SN74ABT16245A . . . DGG, DGV, OR DL PACKAGE (TOP VIEW)



These devices can be used as two 8-bit transceivers or one 16-bit transceiver. They allow data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable  $(\overline{OE})$  input can be used to disable the device so that the buses are effectively isolated.

When  $V_{CC}$  is between 0 and 2.1 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 2.1 V,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54ABT16245 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74ABT16245A is characterized for operation from –40°C to 85°C.



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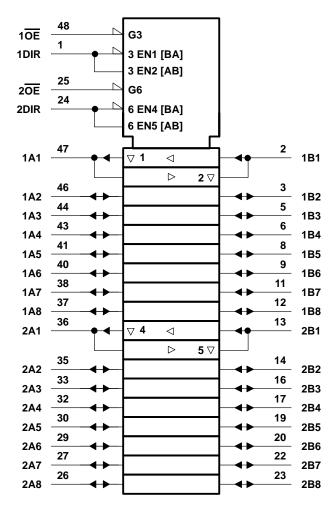


SCBS300C - MARCH 1994 - REVISED MAY 1997

## FUNCTION TABLE (each 8-bit section)

INP	UTS	ODED ATION				
ŌĒ	DIR	OPERATION				
L	L	B data to A bus				
L	Н	A data to B bus				
Н	X	Isolation				

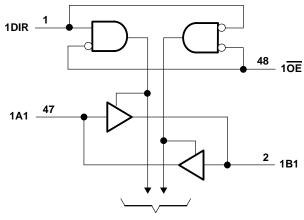
## logic symbol†

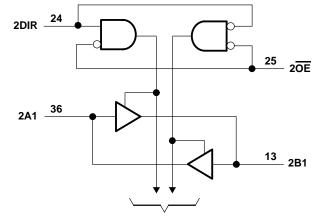


<sup>&</sup>lt;sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



## logic diagram (positive logic)





To Seven Other Channels To Seven Other Channels

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V <sub>CC</sub>	–0.5 V to 7 V
Input voltage range, V <sub>I</sub> (except I/O ports) (see Note 1)	0.5 V to 7 V
Voltage range applied to any output in the high or power-off state, V <sub>O</sub>	−0.5 V to 5.5 V
Current into any output in the low state, IO: SN54ABT16245	96 mA
SN74ABT16245A	128 mA
Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0)	–18 mA
Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0)	–50 mA
Package thermal impedance, θ <sub>JA</sub> (see Note 2): DGG package	89°C/W
DGV package	93°C/W
DL package	94°C/W
Storage temperature range, T <sub>stq</sub>	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

#### recommended operating conditions (see Note 3)

			SN54AB1	Γ16245	SN74ABT1	UNIT	
			MIN	MAX	MIN	MAX	UNII
Vcc	V <sub>CC</sub> Supply voltage		4.5	5.5	4.5	5.5	V
VIH	High-level input voltage		2		2		V
V <sub>IL</sub>	V <sub>IL</sub> Low-level input voltage			0.8		0.8	V
VI	Input voltage		0	VCC	0	Vcc	V
IOH	IOH High-level output current			-24		-32	mA
l <sub>OL</sub>	OL Low-level output current			48		64	mA
Δt/Δν	Input transition rise or fall rate	Outputs enabled		10		10	ns/V
Δt/ΔV <sub>CC</sub>	C Power-up ramp rate		200		200		μs/V
T <sub>A</sub>	Operating free-air temperature		-55	125	-40	85	°C

NOTE 3: Unused pins (input or I/O) must be held high or low to prevent them from floating.



<sup>2.</sup> The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51.

## SN54ABT16245, SN74ABT16245A 16-BIT BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS300C - MARCH 1994 - REVISED MAY 1997

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		T <sub>A</sub> = 25°C		SN54AB1	16245	SN74ABT16245A		UNIT	
PARA	MIETER	1E31 CONDITIONS		MIN	TYP†	MAX	MIN	MAX	MIN	MAX	UNII
VIK		V <sub>CC</sub> = 4.5 V,	I <sub>I</sub> = -18 mA			-1.2		-1.2		-1.2	V
		$V_{CC} = 4.5 \text{ V},$	$I_{OH} = -3 \text{ mA}$	2.5			2.5		2.5		
VOH	Ma	$V_{CC} = 5 V$ ,	$I_{OH} = -3 \text{ mA}$	3			3		3		V
VOH		V <sub>CC</sub> = 4.5 V	$I_{OH} = -24 \text{ mA}$	2			2				
		VCC = 4.5 V	$I_{OH} = -32 \text{ mA}$	2*					2		
VOL		V <sub>CC</sub> = 4.5 V	I <sub>OL</sub> = 48 mA			0.55		0.55			V
VOL		VCC = 4.5 V	I <sub>OL</sub> = 64 mA			0.55*				0.55	V
$V_{hys}$					100						mV
	Control inputs	$V_{CC} = 0$ to 5.5 V, $V_I$	= V <sub>CC</sub> or GND			±1		±1		±1	
11	A or B ports	$V_{CC} = 2.1 \text{ V to } 5.5 \text{ V}$ $V_I = V_{CC} \text{ or GND}$	′,			±20		±100		±20	μΑ
lozpu‡		$V_{CC} = 0 \text{ to } 2.1 \text{ V},$ $V_{O} = 0.5 \text{ V to } 2.7 \text{ V},$	OE = X			±50		±50		±50	μΑ
lozpd‡		$V_{CC} = 2.1 \text{ V to } 0,$ $V_{O} = 0.5 \text{ V to } 2.7 \text{ V}, \overline{OE} = X$				±50	±50		±50		μΑ
lozн§		$V_{CC} = 2.1 \text{ V} \text{ to } 5.5 \text{ V},$ $V_{O} = 2.7 \text{ V}, \overline{OE} \ge 2 \text{ V}$				10¶		10		10¶	μΑ
lozL§		$V_{CC} = 2.1 \text{ V to } 5.5 \text{ V}$ $V_{O} = 0.5 \text{ V}, \text{ OE } \ge 2 \text{ V}$	', /			−10¶		-10		−10¶	μΑ
l <sub>off</sub>		$V_{CC} = 0$ ,	$V_I$ or $V_O \le 4.5 \text{ V}$			±100				±100	μΑ
ICEX		V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 5.5 V	Outputs high			50		50		50	μΑ
lo#		V <sub>CC</sub> = 5.5 V,	V <sub>O</sub> = 2.5 V	-50	-100	-180	-50	-180	-50	-180	mA
		V <sub>CC</sub> = 5.5 V,	Outputs high			2		2		2	
ICC	A or B ports	$I_0 = 0$ ,	Outputs low			32		32		32	mA
		$V_I = V_{CC}$ or GND	Outputs disabled			2		2		2	
	Data inputs	One input at 3.4 V, Other inputs at	Outputs enabled			2		1.5		2	
∆ICC				0.05		1		0.05	mA		
	Control inputs	$V_{CC}$ = 5.5 V, One in Other inputs at $V_{CC}$				1.5		1.5		1.5	
( C:	Control inputs	V <sub>I</sub> = 2.5 V or 0.5 V			3						pF
Co	A or B ports	V <sub>O</sub> = 2.5 V or 0.5 V			6						pF

<sup>\*</sup> On products compliant to MIL-PRF-38535, this parameter does not apply.



<sup>†</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ .

<sup>&</sup>lt;sup>‡</sup>This parameter is characterized, but not production tested.

 $<sup>\</sup>S$  The parameters IOZH and IOZL include the input leakage current.

<sup>¶</sup> This limit may vary among suppliers.

<sup>#</sup>Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

This is the increase in supply current for each input that is at the specified TTL voltage level rather than VCC or GND.

## SN54ABT16245, SN74ABT16245A 16-BIT BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS300C - MARCH 1994 - REVISED MAY 1997

switching characteristics over recommended ranges of supply voltage and operating free-air temperature,  $C_L$  = 50 pF (unless otherwise noted) (see Figure 1)

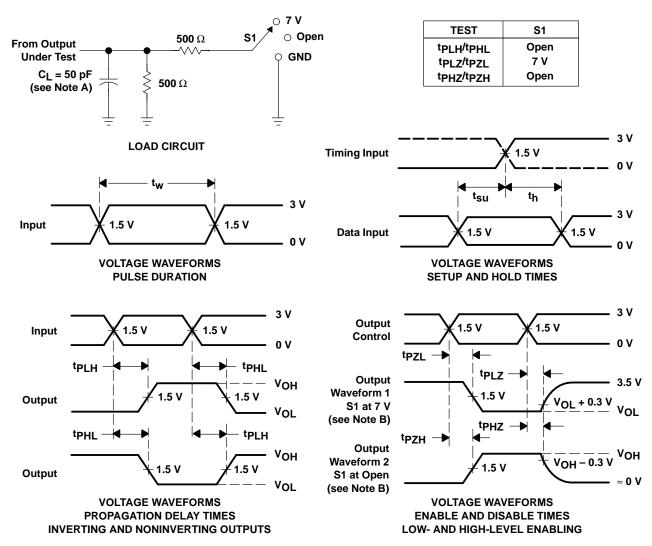
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>(</sub>	CC = 5 V 4 = 25°C	', ;	MIN	MAX	UNIT
			MIN	TYP	MAX			
t <sub>PLH</sub>	A or B	A or B B or A	0.5	2.2	3.4	0.5	4	ns
<sup>t</sup> PHL		BULK	0.5	2.3	3.8	0.5	4.6	115
<sup>t</sup> PZH	ŌĒ	B or A	0.8	3.6	5.2	0.8	5.5	ns
t <sub>PZL</sub>	OE	BUIA	0.9	3.7	6.1	0.9	7.3	115
<sup>t</sup> PHZ	ŌĒ	OF B or A	1.3	4.4	5.8	1.3	6.3	ns
<sup>t</sup> PLZ		BULA	1.4	3.3	4.7	1.4	5.3	115

switching characteristics over recommended ranges of supply voltage and operating free-air temperature,  $C_L$  = 50 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)							
		TO (OUTPUT)	V <sub>C</sub>	CC = 5 V 4 = 25°C	/, ;	MIN	MAX	UNIT
			MIN	TYP	MAX			
t <sub>PLH</sub>	A or B	B or A	1	2.2	3.4	1	3.9	ns
t <sub>PHL</sub>		D OI A	1	2.3	3.7	1	4.2	115
<sup>t</sup> PZH	ŌĒ	B or A	1	3.6	5.2	1	6.3	20
tPZL	OE	D OI A	1	3.7	5.4	1	6.4	ns
<sup>t</sup> PHZ	ŌĒ	B or A	2	4.4	5.8	2	6.3	ns
t <sub>PLZ</sub>		BULK	1.5	3.3	4.7	1.5	5.2	115

SCBS300C - MARCH 1994 - REVISED MAY 1997

#### PARAMETER MEASUREMENT INFORMATION



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_{Q}$  = 50  $\Omega$ ,  $t_{f} \leq$  2.5 ns,  $t_{f} \leq$  2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



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